

General Description

The MY12N65F is silicon N-channel Enhanced VDMOSFETs, obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy.

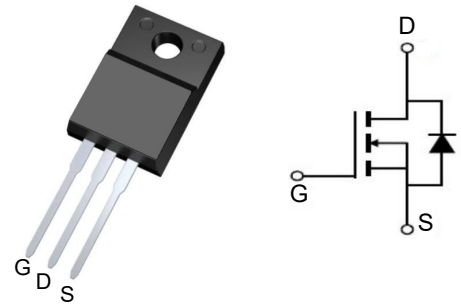


Features

V_{DSS}	650	V
I_D	12	A
P_D ($T_C = 25\text{ }^\circ\text{C}$)	51	W
$R_{DS(ON)}$ (at $V_{GS} = 10\text{V}$)	0.7	Ω

Application

- High efficiency switch mode power supplies
- Power factor correction
- Electronic lamp ballast



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MY12N65F	TO-220F	MY12N65F	1000

Absolute Maximum Ratings ($T_C = 25\text{ }^\circ\text{C}$ unless otherwise noted)

Symbol	Parameters	Ratings	Unit
V_{DSS}	Drain-Source Voltage	650	V
V_{GS}	Gate-Source Voltage-Continuous	± 30	V
I_D	Drain Current-Continuous (Note 2)	12	A
I_{DM}	Drain Current-Single Plused (Note 1)	48	A
P_D	Power Dissipation (Note 2)	51	W
T_j	Max.Operating junction temperature	150	$^\circ\text{C/W}$

Electrical Characteristics (T_c=25 °C, unless otherwise noted)

Symbol	Parameters	Min	Typ	Max	Units	Conditions
Static Characteristics						
B _{VDSS}	Drain-Source Breakdown VoltageCurrent (Note 1)	650	--	--	mA	I _D =250μA V _{GS} =0V , T _J =25°C
V _{GS(th)}	Gate Threshold Voltage	2.0	--	4.0	V	V _{DS} =V _{GS} , I _D =250μA
R _{DS(on)}	Drain-Source On-Resistance	--	0.7	0.9	Ω	V _{GS} =10V , I _D =6A
I _{GSS}	Gate-Body Leakage Current	--	--	±100	nA	V _{GS} =±30V , V _{DS} =0
I _{DSS}	Zero Gate Voltage Drain Current	--	--	1	μA	V _{DS} =650V , V _{GS} =0
g _{fs}	Forward Transconductance	3.6	--	--	S	V _{DS} =15V , I _D =5A
Switching Characteristics						
T _{d (on)}	Turn-On Delay Time	--	30	75	ns	V _{DS} =325V , I _D =12A, R _G =25Ω (Note 2)
T _r	Rise Time	--	115	240	ns	
T _{d (off)}	Turn-Off Delay Time	--	95	205	ns	
T _f	Fall Time	--	85	180	ns	
Q _g	Total Gate Charge	--	42	55	nC	V _{DS} =520, V _{GS} =10V , I _D =12A (Note 2)
Q _{gs}	Gate-Source Charge	--	8.5	--	nC	
Q _{gd}	Gate-Drain Charge	--	21.5	--	nC	
Dynamic Characteristics						
C _{iss}	Input Capacitance	--	1460	--	pF	V _{DS} =25V , V _{GS} =0, f=1MHz
C _{oss}	Output Capacitance	--	205	--	pF	
C _{rss}	Reverse Transfer Capacitance	--	24.8	--	pF	
I _S	Continuous Drain-Source Diode Forward Current (Note 2)	--	--	12	A	
V _{SD}	Diode Forward On-Voltage	--	--	1.4	V	I _S =12A , V _{GS} =0
R _{th(j-c)}	Thermal Resistance, Junction to Case	--	--	3.65	°C/W	

Note 1: Repetitive Rating : Pulse width limited by maximum junction temperature

Note 2: Pulse test: PW ≤ 300us , duty cycle ≤ 2%.

Ratings and Characteristic curves

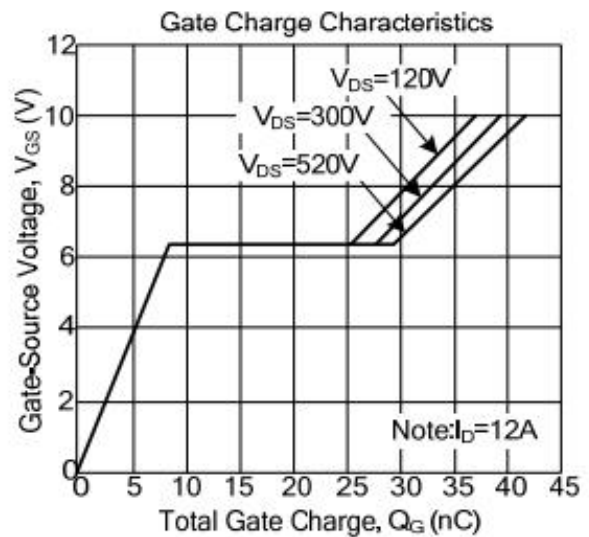
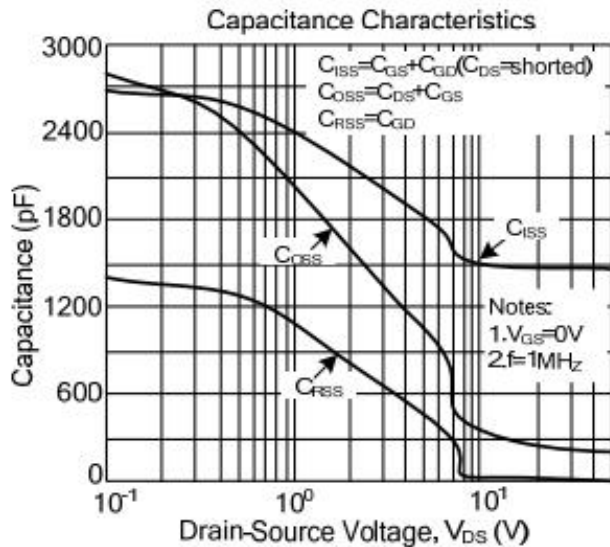
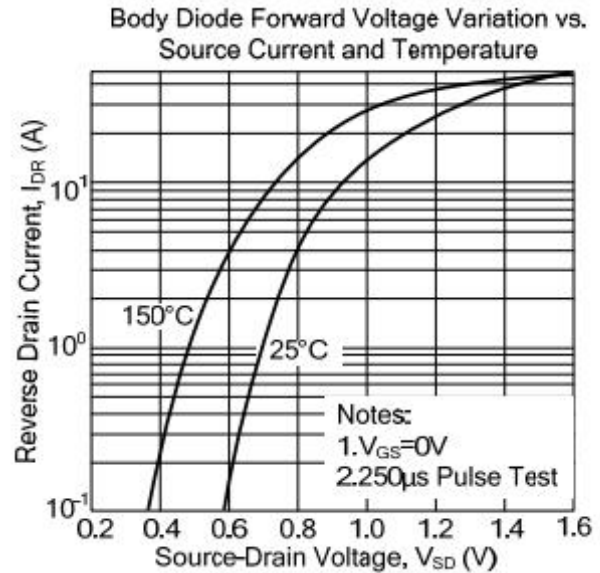
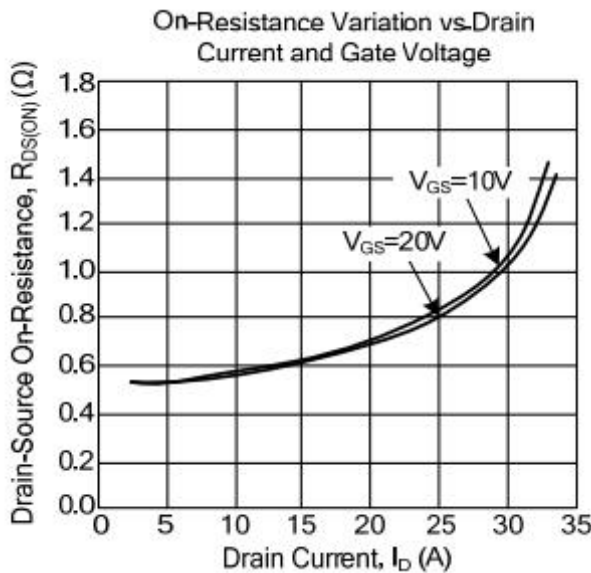
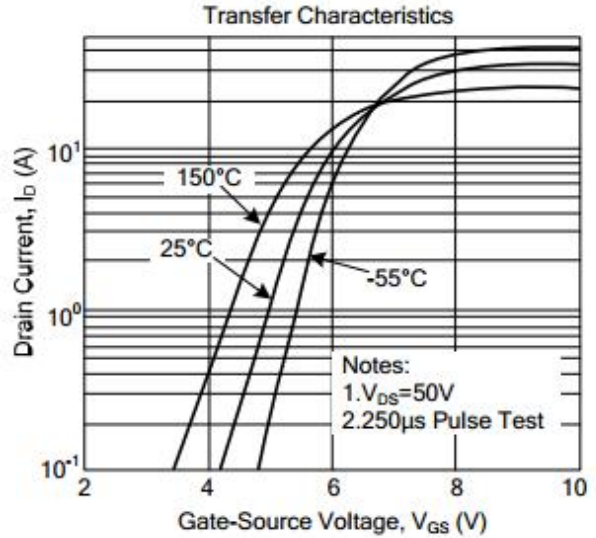
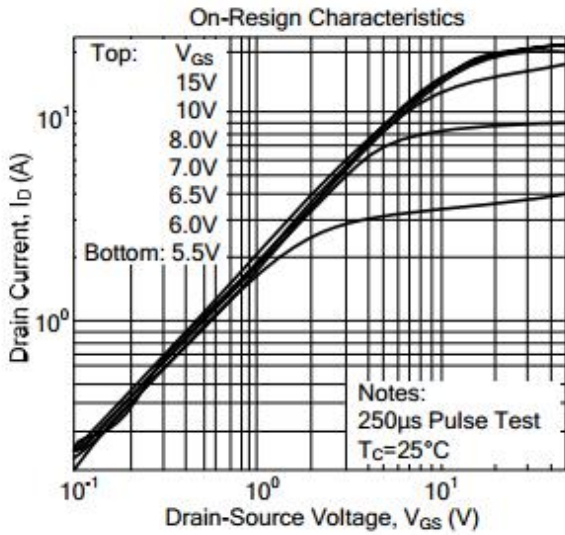


Fig 12. Gate Charge Test Circuit & Waveform

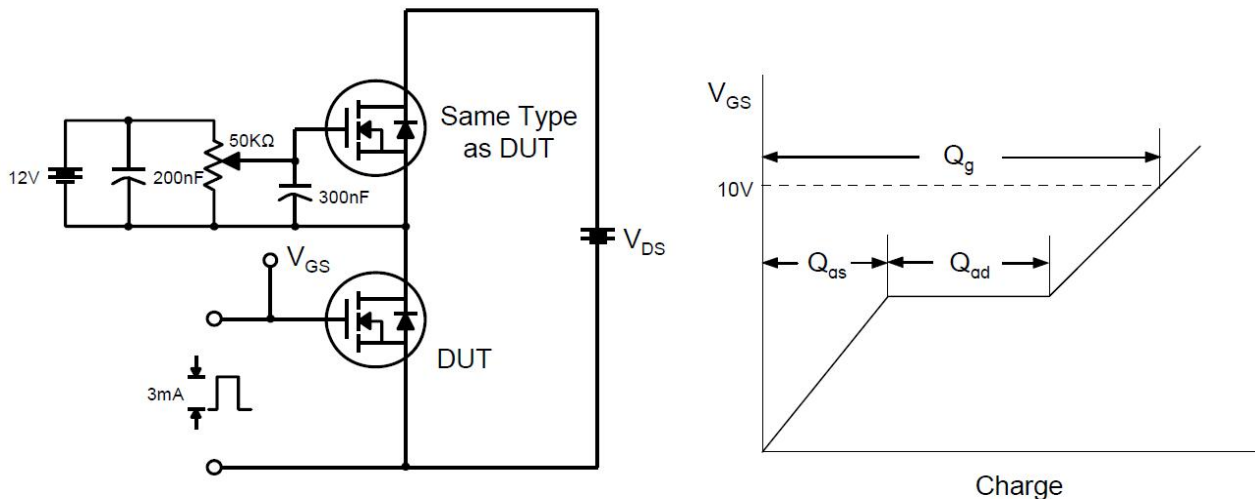


Fig 13. Resistive Switching Test Circuit & Waveforms

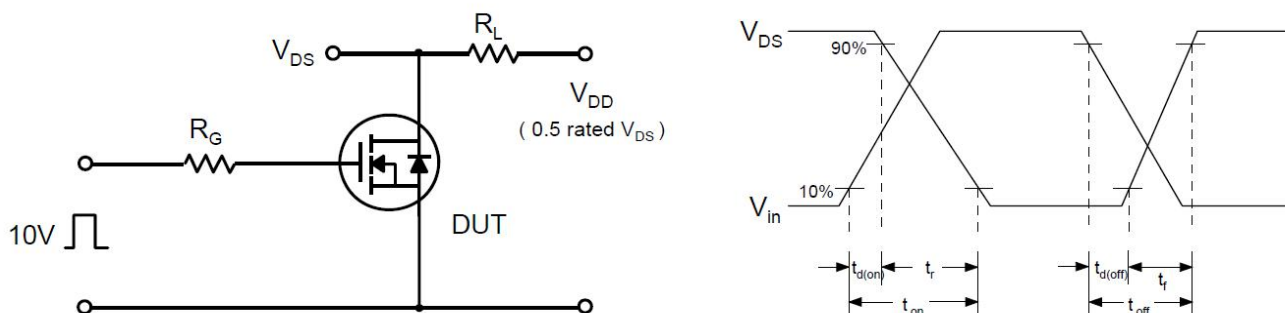


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

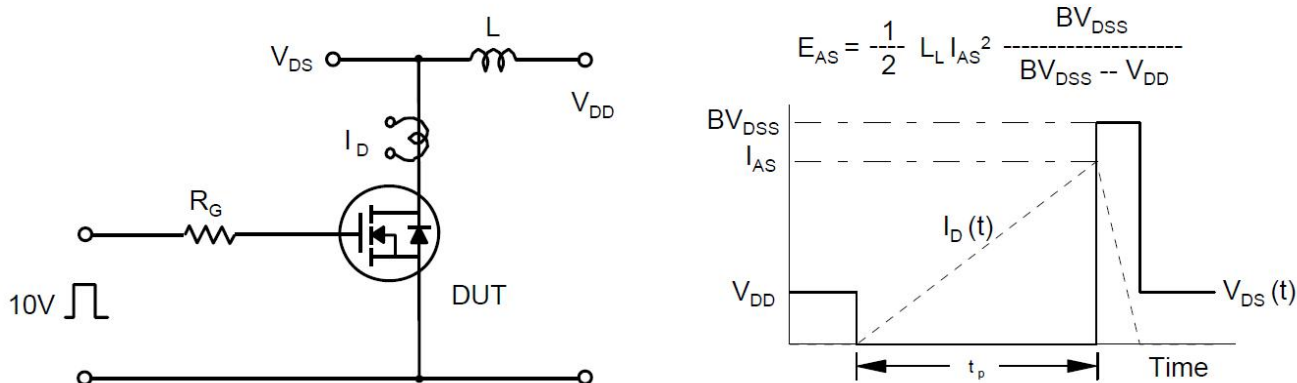
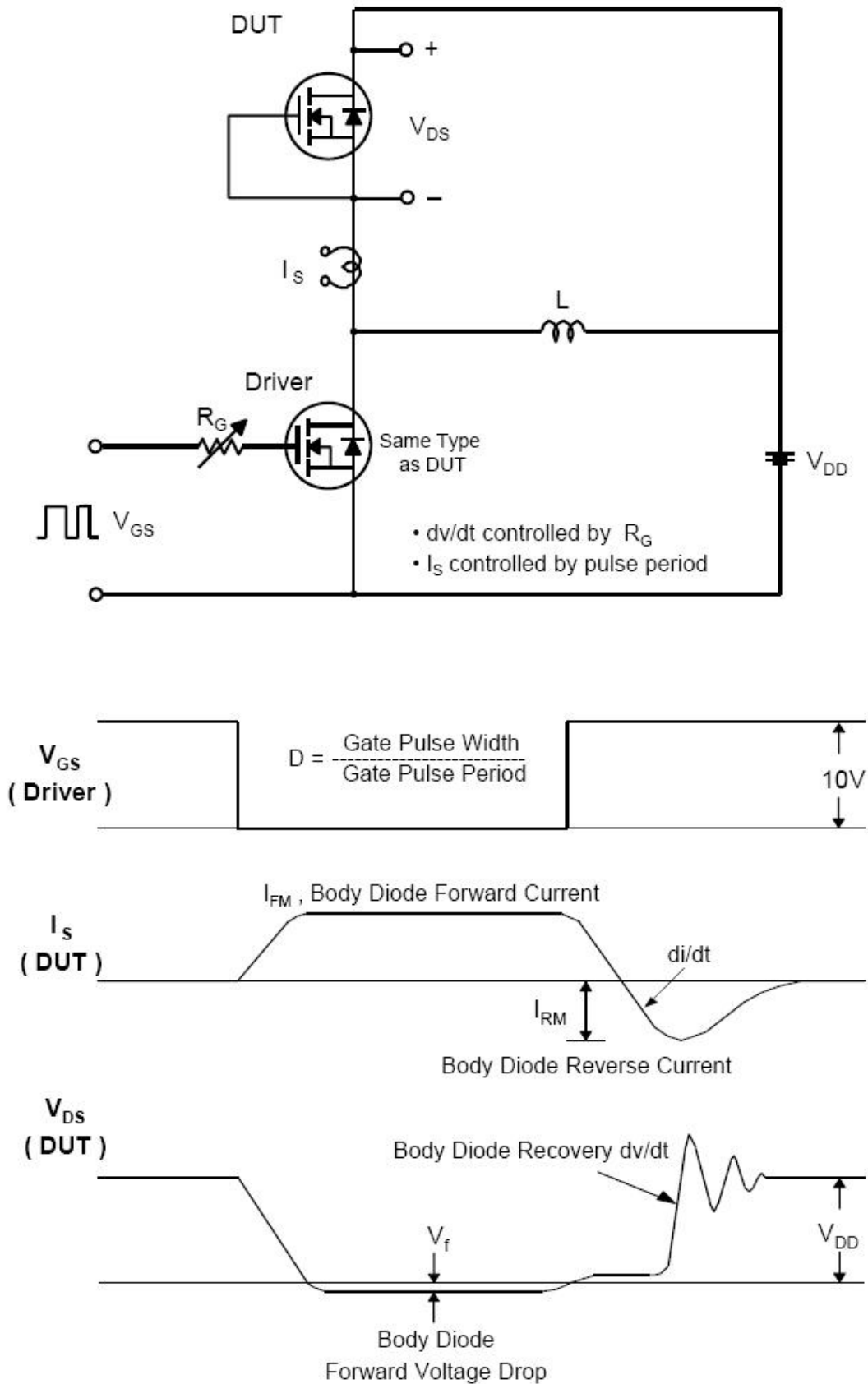
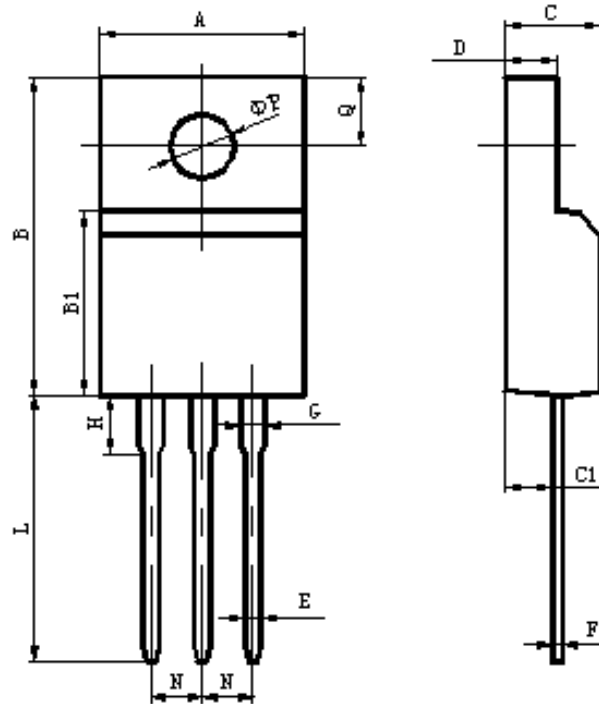


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Mechanical Data-TO-220F Single



Items	Values(mm)	
	MIN	MAX
A	9.60	10.4
B	15.4	16.2
B1	8.90	9.50
C	4.30	4.90
C1	2.10	3.00
D	2.40	3.00
E	0.60	1.00
F	0.30	0.60
G	1.12	1.42
H	3.40	3.80
	2.40	2.90
L*	12.0	14.0
N	2.34	2.74
Q	3.15	3.55
phi P	2.90	3.30